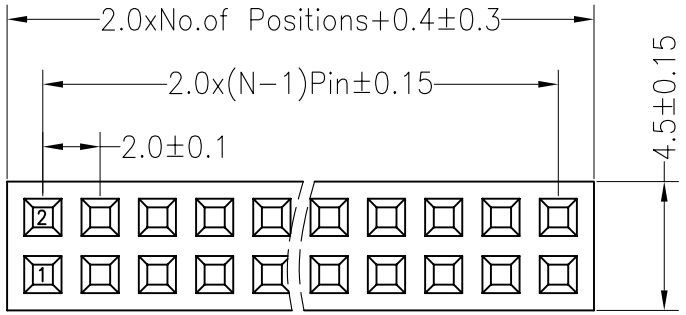
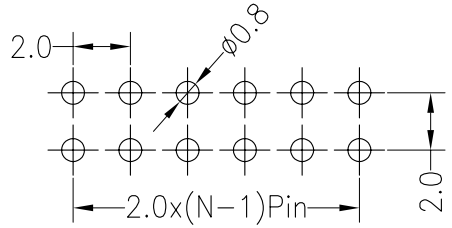
HSF RoHS FILE NO:E362810

SPECIFICATIONS
Rated Current:1.5AMP
Contact Resistance:20mΩ Max
Withstand Voltage:500V AC/DC
Insulation Resistance:1000MΩ Min
Operation Temperature:−40°c to +105°c

Contact Material:Brass
Contact Plating:Au or Sn Over Ni
Insulator Material:Polyester(UL94V−0)
Standard: PA6T
Max.Processing Temp: 230°C for 30−60 seconds
(260°C for 10 seconds)



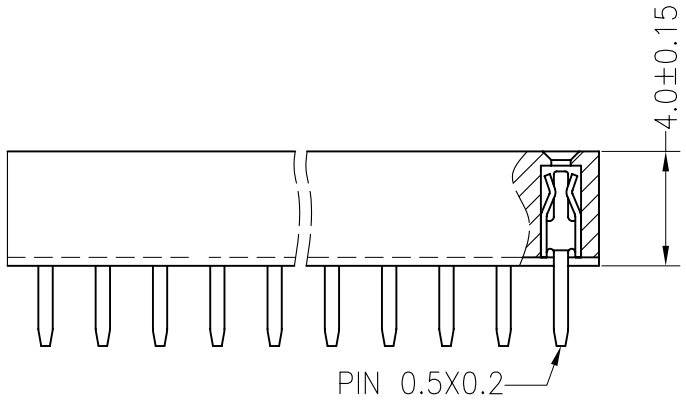
Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)

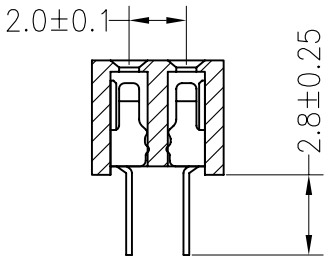


Ordering Information

2340 02 XX X N XX S U X 02

- XX — No.of Pins Per Row 2*2~2*40
- X — Insulator Material Option
  A=BK−PBT
  B=BK−PA66
  C=BK−PA6T
  D=BK−PA46
  E=BK−PA9T
  F=BK−LCP
- XX — Contact Plating
  G0:Gold Flash
  G1:3U" Gold
  G2:5U" Gold
  G3:10U" Gold
  G4:15U" Gold
  G5:30U" Gold
  S0:Gold Flash/Tin
  SN:Tin
- X — Packing
  A=Tray
  T=Tube
  P=Tube+Cap
  R=Reel+Cap
  M=Reel+Mylar





REV	DATE	MODIFICATION DESCRIPTION	CHANGE
A0	2012.07.23	NEW DRAWING	

OPERATION	
X.X	±0.30
X.XX	±0.20
X.XXX	±0.10
Angle	±3°
DIM	TOL

DRAW	Liu Miao	12.07.23
CHECK		
APPROVE		

SCALE	FIT
UNIT	mm
SIZE	A4
SHEET	1/1
PROJ.	

WFD CONN 深圳市旺富达电子有限公司
SHEN ZHEN WFD ELECTRONICS CO., LTD

PART NO.	234002XXXNXXSUX02
TITLE:	2.00PF H4.0mm 2xNpin 180° W4.50